# **INTERNATIONAL STANDARD**

**ISO** 9453

Third edition 2014-08-01

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### **Foreword**

ISO (the International Organization for Standardization) is a worldwide federation of national standards bodies (ISO member bodies). The work of preparing International Standards is normally carried out through ISO technical committees. Each member body interested in a subject for which a technical committee has been established has the right to be represented on that committee. International organizations, governmental and non-governmental, in liaison with ISO, also take part in the work. ISO collaborates closely with the International Electrotechnical Commission (IEC) on all matters of electrotechnical standardization.

The procedures used to develop this document and those intended for its further maintenance are described in the ISO/IEC Directives, Part 1. In particular the different approval criteria needed for the different types of ISO documents should be noted. This document was drafted in accordance with the editorial rules of the ISO/IEC Directives, Part 2. www.iso.org/directives

Attention is drawn to the possibility that some of the elements of this document may be the subject of patent rights. ISO shall not be held responsible for identifying any or all such patent rights. Details of any patent rights identified during the development of the document will be in the Introduction and/or on the ISO list of patent declarations received. www.iso.org/patents

Any trade name used in this document is information given for the convenience of users and does not constitute an endorsement.

For an explanation on the meaning of ISO specific terms and expressions related to conformity assessment, as well as information about ISO's adherence to the WTO principles in the Technical Barriers to Trade (TBT), see the following URL: Foreword - Supplementary information

The committee responsible for this document is ISO/TC 44, *Welding*, Subcommittee SC 12, *Soldering materials*.

This third edition cancels and replaces the second edition (ISO 9453:2006), which has been technically revised.

Request for an official interpretation of technical aspects of this International Standard should be directed to the relevant secretariat of ISO/TC 44/SC 12 "Soldering materials" via the user's national standardization body; a listing of these bodies can be found at: http://www.iso.org.

## Introduction

The International Organization for Standardization (ISO) draws attention to the fact that it is claimed that compliance with this document may involve the use of patents concerning soft solder alloy compositions given in Table 3.

ISO takes no position concerning the evidence, validity and scope of this patent right.

The holder of this patent right has ensured the ISO that he/she is willing to negotiate licences either free of charge or under reasonable and non-discriminatory terms and conditions with applicants throughout the world. In this respect, the statement of the holder of this patent right is registered with ISO. Information may be obtained from Annex B.

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ISO (www.iso.org/patents) maintains online databases of patents relevant to their standards. Users are encouraged to consult the databases for the most up to date information concerning patents. A Protection Some and String.

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# Soft solder alloys — Chemical compositions and forms

### 1 Scope

### WARNING — National or regional regulations may limit the employment of certain alloys.

This International Standard specifies the requirements for chemical composition for soft solder alloys containing two or more of tin, lead, antimony, copper, silver, bismuth, zinc, indium and/or cadmium.

An indication of the forms generally available is also included.

### 2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

ISO 3677, Filler metal for soft soldering, brazing and braze welding — Designation

### 3 Terms and definitions

For the purposes of this document, the following terms and definitions apply.

### 3.1

### soft solder

metallic filler material which is used to join metallic parts and which has a melting temperature (liquidus) lower than that of the parts to be joined and, usually, lower than  $450\,^{\circ}\text{C}$  and which wets the parent metals

### 3.2

### batch

collection of one or more units of product, made in a single production operation

# 4 Chemical composition

The chemical composition of the soft solder, sampled and analysed in accordance with <u>Clause 6</u>, shall be as given for the appropriate material in <u>Table 1</u> or <u>Table 2</u>.

### 5 Forms of delivery

### 5.1 General

Soft solders conforming to this International Standard shall be supplied in one of the following forms: ingot, slab, stick, bar, rod, wire, pellets, preforms, rings, spheres, ribbons, powder or soldering pastes. Solder shall be uniform in quality and free from detrimental conditions such as contamination or surface oxide that prevent melting and flow in a manner suitable for the intended application.

NOTE 1 Solders supplied in the form of rod, wire, or preforms can be supplied with or without an integral flux, subject to agreement between the supplier and the purchaser.

NOTE 2 Not all the solder compositions given in the tables are necessarily available in all the product forms listed.